### INTEGRATED CIRCUITS

# DATA SHEET

# PCA2002 32 kHz watch circuit with programmable output period and pulse width

Product specification Supersedes data of 2003 Feb 04 2004 Jan 20





### 32 kHz watch circuit with programmable output period and pulse width

**PCA2002** 

#### **FEATURES**

- 32 kHz quartz oscillator, amplitude regulated with excellent frequency stability and high immunity to leakage currents
- Electrically programmable time calibration with 1 ppm resolution (stored in OTP memory)
- The quartz crystal is the only external component required
- · Very low current consumption: typically 90 nA
- · Output pulses for bipolar stepping motors
- Five different programmable output periods (1 s to 30 s)
- Output pulse width programmable between 1 ms and 8 ms
- Full or chopped motor pulse and pulse stretching, selectable
- Stop function for accurate time setting and current saving during the shelf life
- Test mode for accelerated testing of the mechanical parts of the watch.

#### **GENERAL DESCRIPTION**

The PCA2002 is a CMOS integrated circuit for battery operated wrist watches with a 32 kHz quartz crystal as the timing element and a bipolar stepping motor. The crystal oscillator and the frequency divider are optimized for minimum current consumption. A timing accuracy of 1 ppm is achieved with a programmable, digital frequency adjustment.

The output period and the output pulse width can be programmed. It can be selected between a full output pulse or a chopped output pulse with a duty cycle of 75 %. In addition, a stretching pulse can be added to the primary driving pulse.

Pin RESET is used for stopping the motor, accurate time setting and for an accelerated testing of the watch.

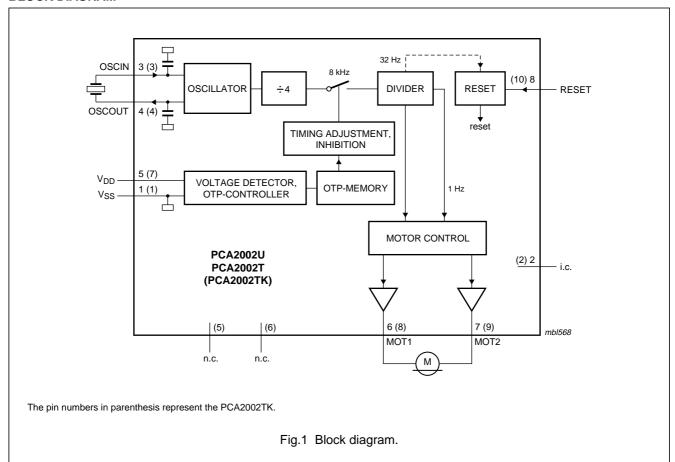
#### **ORDERING INFORMATION**

| TYPE NUMBER   | PACKAGE |  |          |  |  |  |
|---------------|---------|--|----------|--|--|--|
| I THE NUMBER  | NAME    | DESCRIPTION  |          |  |  |  |
| PCA2002U/AA   | _       | bare die; chip in tray   | _        |  |  |  |
| PCA2002U/10AA | _       | bare die; chip on film frame carrier   | _        |  |  |  |
| PCA2002T      | PMFP8   | plastic micro flat package; 8 leads (straight)   | SOT144-1 |  |  |  |
| PCA2002TK     | HVSON10 | plastic thermal enhanced very thin small outline package; no leads; 10 terminals; body $3\times3\times0.85$ mm | SOT650-1 |  |  |  |

# 32 kHz watch circuit with programmable output period and pulse width

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#### **BLOCK DIAGRAM**

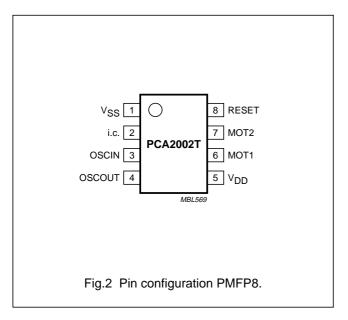


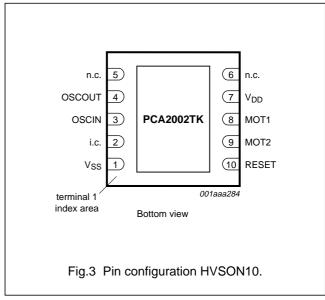
#### **PINNING**

| CVMDOL          | PAD      | PIN      |           | DESCRIPTION          |
|-----------------|----------|----------|-----------|----------------------|
| SYMBOL          | PCA2002U | PCA2002T | PCA2002TK | DESCRIPTION          |
| V <sub>SS</sub> | 1        | 1        | 1         | ground               |
| i.c.            | 2        | 2        | 2         | internally connected |
| OSCIN           | 3        | 3        | 3         | oscillator input     |
| OSCOUT          | 4        | 4        | 4         | oscillator output    |
| n.c.            | _        | _        | 5         | not connected        |
| n.c.            | _        | _        | 6         | not connected        |
| $V_{DD}$        | 5        | 5        | 7         | supply voltage       |
| MOT1            | 6        | 6        | 8         | motor 1 output       |
| MOT2            | 7        | 7        | 9         | motor 2 output       |
| RESET           | 8        | 8        | 10        | reset input          |

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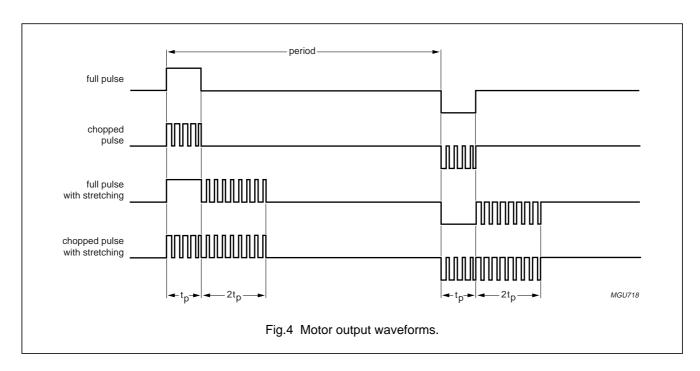
#### **FUNCTIONAL DESCRIPTION**

#### Motor pulse

The motor driver delivers pulses with an alternating polarity. The output waveform across the motor terminals is illustrated in Fig.4. Between the motor pulses, both terminals are connected to  $V_{DD}$  which means that the motor is short-circuited.

The following parameters can be selected and are stored in a One Time Programmable (OTP) memory:

- Output periods of 1 s, 5 s, 10 s, 20 s and 30 s
- Pulse width (t<sub>p</sub>) between 0.98 ms and 7.8 ms in steps of 0.98 ms
- Full or chopped (75 %) output pulse
- Pulse stretching: an enlargement pulse is added to the primary motor pulse. This enlargement pulse has a duty cycle of 25 % and a width which is twice the programmed motor pulse width.



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#### Time calibration

The crystal oscillator has an integrated load capacitance of 5 pF, which is lower than the specified load capacitance of 8.2 pF for the quartz crystal.

It oscillates therefore, at a frequency which is typically 60 ppm higher than 32.768 kHz. This positive frequency offset is then compensated by removing, every minute or every two minutes, the appropriate number of 8192 Hz pulses (maximum 127 pulses) of the divider chain. The timing correction is given in Table 1.

After measuring the effective oscillator frequency, the number of correction pulses must be calculated and stored

together with the calibration period in the OTP memory; see Section "Programming procedure".

The oscillator frequency can be measured at pad RESET, where a square wave signal with the frequency of

$$\frac{1}{1024} \times f_{osc}$$
 is provided.

This frequency shows a jitter every minute or every two minutes, depending on the programmed calibration period, which originates from the time calibration.

Details on how to measure the oscillator frequency and the programmed inhibition time are given in Section "Programming procedure".

Table 1 Timing correction

| CALIBRATION  | CORRECTION P | ER STEP (N = 1) | CORRECTION PER STEP (N = 127) |       |  |
|--------------|--------------|-----------------|-------------------------------|-------|--|
| PERIOD (min) | ppm          | s/day           | ppm                           | s/day |  |
| 1            | 2.03         | 0.176           | 258                           | 22.3  |  |
| 2            | 1.017        | 0.088           | 129                           | 11.15 |  |

#### Reset

At pin RESET an output signal with a frequency of  $\frac{1}{1024} \times f_{osc} = 32$  Hz is provided.

Connecting pin RESET to V<sub>DD</sub> stops the motor drive and opens the motor switches.

After releasing pin RESET, the first motor pulse is generated exactly one period later with the opposite

polarity to the last pulse before stopping. The debounce time for the reset function is between 31 ms and 62 ms.

Connecting pin RESET to  $V_{SS}$  activates the test mode. In this mode the motor output frequency is 32 Hz, which can be used to test the mechanical function of the watch.

#### **Programming possibilities**

The programming data is stored in two words; see Table 2.

Table 2 Words and bits

| WORD | ВІТ                                    |             |  |  |                        |                    |  |                  |
|------|--|-------------|--|--|------------------------|--------------------|--|------------------|
| WORD | 1 2 3 4 5 6 7                          |             |  |  |                        | 8                  |  |                  |
| Α    | number of 8192 Hz pulses to be removed |             |  |  |                        | calibration period |  |                  |
| В    |  | pulse width |  |  | output period duty cyc |                    |  | pulse stretching |

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Table 3 Description of word A bits

| BIT     | VALUE          | DESCRIPTION   |  |  |
|---------|----------------|---|--|--|
| Inhibit |                |   |  |  |
| 1 to 7  | _              | the number of the 8192 Hz pulses to<br>be removed (binary coded;<br>MSB = A1, LSB = A7) |  |  |
| Calibra | bration period |   |  |  |
| 8       | 0              | 1 minute  |  |  |
|         | 1              | 2 minutes   |  |  |

Table 4 Description of word B bits

| BIT               | VALUE                   | DESCRIPTION   |  |
|-------------------|-------------------------|---|--|
| Pulse v           | vidth t <sub>p</sub> (n | ns)   |  |
| 1 to 3            | 000                     | 0.98  |  |
|                   | 001                     | 1.95  |  |
|                   | 010                     | 2.9   |  |
|                   | 011                     | 3.9   |  |
|                   | 100                     | 4.9   |  |
|                   | 101                     | 5.9   |  |
|                   | 110                     | 6.8   |  |
|                   | 111                     | 7.8   |  |
| Output period (s) |                         |   |  |
| 4 to 6            | 000                     | 1   |  |
|                   | 001                     | 5   |  |
|                   | 010                     | 10  |  |
|                   | 011                     | 20  |  |
|                   | 100                     | 30  |  |
| Duty cy           | cle of mo               | otor pulse  |  |
| 7                 | 0                       | 75 %  |  |
|                   | 1                       | 100 %   |  |
| Pulse s           | tretching               |   |  |
| 8                 | 0                       | no pulse stretching   |  |
|                   | 1                       | a pulse width of 2t <sub>p</sub> and a duty factor of 25 % is added |  |

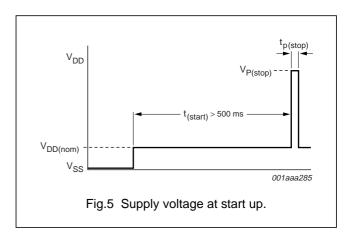
#### General start up sequence

You must follow the next sequence to ensure the correct operation at start up:

- 1. Apply the supply voltage to the circuit.
- 2. Wait at least two seconds.
- 3. Connect pin RESET to pin  $V_{DD}$  for a minimum of 62 ms (this activates the stop mode).
- 4. Disconnect pin RESET from pin V<sub>DD</sub> (this resets the circuit to normal operating mode).

After this sequence the memory contents are read immediately and the programmed options are set. This sequence also resets all major circuit blocks and ensures that they function correctly.

To ensure that the oscillator starts up correctly you must execute a reset sequence (see Fig.5).



#### Programming procedure

For a watch it is essential that the timing calibration can be made after the watch is fully assembled. In this situation, the supply pins are often the only terminals which are still accessible.

Writing to the OTP cells and performing the related functional checks is achieved in the PCA2002 by modulating the supply voltage. The necessary control circuit consists basically of a voltage level detector, an instruction state counter (which determines the function to be performed) and an 8-bit shift register which allows writing the OTP cells of an 8-bit word in one step and which acts as data pointer for checking the OTP content.

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There are four different instruction states:

- State 1; measurement of the crystal oscillator frequency (divided by 1024)
- State 2; measurement of the inhibition time
- · State 3; write/check word A
- State 4; write/check word B.

Each instruction state is switched on with a pulse to  $V_{P(start)}$ . After this large pulse, an initial waiting time of  $t_0$  is required. The programming instructions are then entered by modulating the supply voltage with small pulses of an amplitude  $V_{P(mod)}$  and pulse width  $t_{mod}$ . The first small pulse defines the start time, the following pulses perform three different functions, depending on the time delay  $(t_d)$  from the preceding pulse (see Fig.6):

- $t_d = t_1$  (0.7 ms); increments the instruction counter
- t<sub>d</sub> = t<sub>2</sub> (1.7 ms); clocks the shift register with D = 0 at the input
- t<sub>d</sub> = t<sub>3</sub> (2.7 ms); clocks the shift register with D = 1 at the input.

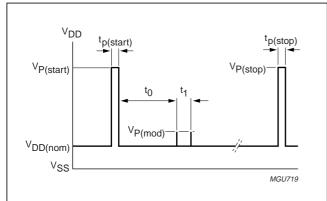


Fig.6 Supply voltage modulation for start and stop of instruction state 2.

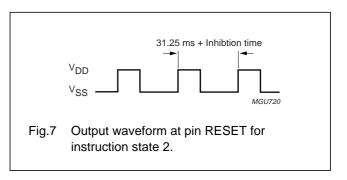
The programming procedure requires a stable oscillator, which means that a waiting time, determined by the start-up time of the oscillator, is necessary after power-up of the circuit.

After the  $V_{P(start)}$  pulse, the instruction counter is in state 1 and the data shift register is cleared. The instruction state ends with a second pulse to  $V_{P(start)}$  or with the pulse to  $V_{store}$ . In any event the instruction states are terminated automatically 2 seconds after the last  $V_{P(mod)}$  pulse.

MEASUREMENT OF OSCILLATOR FREQUENCY AND INHIBIT TIME

The output of the two measuring states can either be monitored directly at pin RESET or as a modulation of the supply current (a modulating resistor of 30 k $\Omega$  is connected between V<sub>DD</sub> and V<sub>SS</sub> when the signal at pin RESET is HIGH):

- State 1; crystal oscillator frequency divided by 1024; state 1 starts with a pulse to V<sub>P(start)</sub> and ends with a second pulse to V<sub>P(stop)</sub>
- State 2; inhibition time (see Fig.7); a frequency with the period of (31.25 + n × 0.122) ms appears at pin RESET and as current modulation at the supply pin.



PROGRAMMING THE MEMORY CELLS

Applying the two-stage programming pulse (see Fig.8) transfers the stored data in the shift register to the OTP cells.

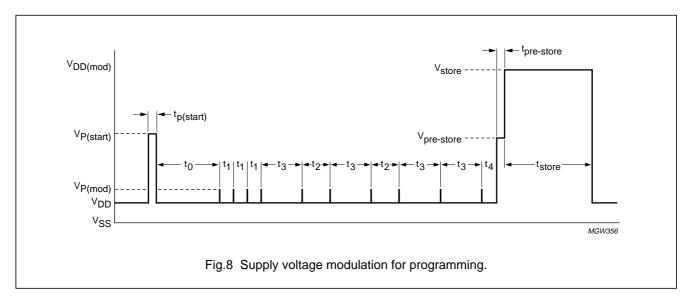
Perform the following to programme a memory word:

- Starting with a V<sub>P(start)</sub> pulse, wait for the time period t<sub>0</sub> then set the instruction counter to the word to be written (t<sub>d</sub> = t<sub>1</sub>)
- Enter the data to be stored into the shift register (t<sub>d</sub> = t<sub>2</sub> or t<sub>3</sub>), LSB first (bit 8) and MSB last (bit 1)
- 3. Applying the two-stage programming pulse  $V_{pre-store}$  followed by  $V_{store}$  stores the word. The delay between the last data bit and the pre-store pulse  $V_{pre-store}$  is  $t_d = t_4$ . Store the word by raising the supply voltage to  $V_{store}$  (9.9 V for 100 ms); the delay between the last data bit and the store pulse is  $t_d = t_4$  (0.2 ms).

The example shown in Fig.8 performs the following functions: start, setting the instruction counter to state 4 (word B), entering data word 110101 into the shift register (sequence: LSB first and MSB last) and writing the OTP cells for word B.

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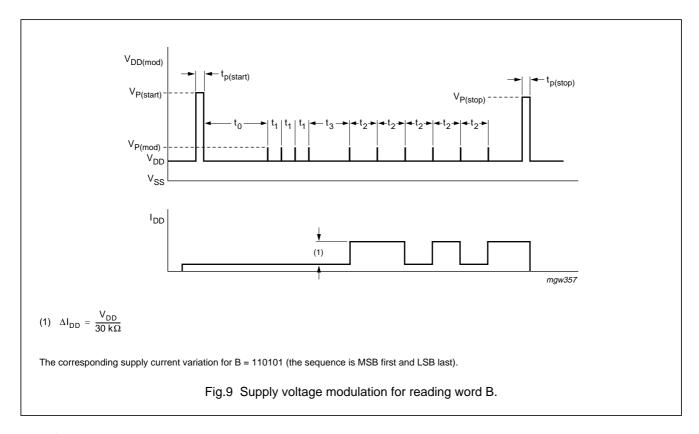
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#### CHECKING THE MEMORY CONTENT

The stored data of the OTP array can be checked bit-wise by measuring the supply current. The array word is selected by the instruction state, the bit is addressed by the shift register. To read a word, the word is first selected ( $t_d = t_1$ ) and a logic 1 is written into the first cell of the shift register ( $t_d = t_3$ ).

This logic 1 is then shifted through the entire shift register ( $t_d = t_2$ , so that it points with each clock pulse to the next bit. If the addressed OTP cell contains a logic 1, a 30 k $\Omega$  resistor is connected between  $V_{DD}$  and  $V_{SS}$ ; this increases the supply current accordingly.

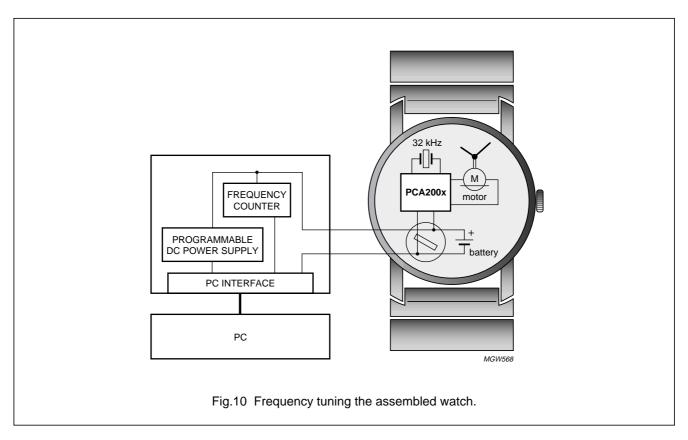


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#### Frequency tuning at assembled watch

Figure 10 shows the test set-up for frequency tuning the assembled watch.



#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL           | PARAMETER                   | CONDITIONS                           | MIN.                  | MAX.                  | UNIT |
|------------------|-----------------------------|--------------------------------------|-----------------------|-----------------------|------|
| $V_{DD}$         | supply voltage              | V <sub>SS</sub> = 0 V; notes 1 and 2 | -1.8                  | +7                    | V    |
| VI               | all input voltages          |                                      | V <sub>SS</sub> – 0.5 | V <sub>DD</sub> + 0.5 | V    |
| t <sub>sc</sub>  | short-circuit duration time |                                      |                       | indefinite            |      |
| T <sub>amb</sub> | ambient temperature         |                                      | -10                   | +60                   | °C   |
| T <sub>stg</sub> | storage temperature         |                                      | -30                   | +100                  | °C   |

#### **Notes**

- 1. When writing to the OTP cells, the supply voltage (V<sub>DD</sub>) can be raised to a maximum of 12 V for a time period of 1 s.
- Connecting the battery with reversed polarity does not destroy the circuit, but in this condition a large current flows which rapidly discharges the battery.

#### HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However it is good practice to take normal precautions appropriate to handling MOS devices (see "Handling MOS devices").

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#### **CHARACTERISTICS**

 $V_{DD}$  = 1.55 V;  $V_{SS}$  = 0 V;  $f_{osc}$  = 32.768 kHz;  $T_{amb}$  = 25 °C; quartz crystal;  $R_s$  = 40 k $\Omega$ ;  $C_1$  = 2 to 3 fF;  $C_L$  = 8.2 pF; unless otherwise specified.

| SYMBOL             | PARAMETER                          | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|--------------------|------------------------------------|--|------|------|------|------|
| Supplies           |                                    |  | '    | '    |      | -1   |
| $V_{DD}$           | supply voltage                     | normal operating mode;<br>T <sub>amb</sub> = -10 °C to +60 °C        | 1.1  | 1.55 | 3.6  | V    |
| $\Delta V_{DD}$    | supply voltage variation           | $\Delta V/\Delta t = 1 V/\mu s$                                      | _    | _    | 0.25 | V    |
| I <sub>DD</sub>    | supply current                     | between motor pulses   | _    | 90   | 120  | nA   |
|                    |                                    | between motor pulses at V <sub>DD</sub> = 3.5 V                      | _    | 120  | 180  | nA   |
|                    |                                    | $T_{amb} = -10 ^{\circ}\text{C} \text{ to } +60 ^{\circ}\text{C}$    | _    | _    | 200  | nA   |
|                    |                                    | stop mode; pin RESET connected to V <sub>DD</sub>                    | _    | 100  | 135  | nA   |
| Motor outp         | ut                                 |  |      |      |      |      |
| V <sub>sat</sub>   | saturation voltage $\Sigma(P + N)$ | $R_{M} = 2 \text{ k}\Omega;$<br>$T_{amb} = -10 \text{ °C to +60 °C}$ | _    | 150  | 200  | mV   |
| Z <sub>o(sc)</sub> | short-circuit impedance            | between motor pulses;<br>I <sub>motor</sub> < 1 mA                   | _    | 200  | 300  | Ω    |
| Oscillator         |                                    |  |      | •    | •    | •    |
| V <sub>start</sub> | starting voltage                   |  | 1.1  | _    |      | V    |
| g <sub>m</sub>     | transconductance                   | V <sub>OSCIN</sub> ≤ 50 mV (p-p)                                     | 5    | 10   | _    | μS   |
| t <sub>su</sub>    | start-up time                      |  | _    | 0.3  | 0.9  | s    |
| Δf/f               | frequency stability                | $\Delta V_{DD} = 100 \text{ mV}$                                     | _    | 0.05 | 0.2  | ppm  |
| C <sub>L</sub>     | integrated load capacitance        |  | 4.3  | 5.2  | 6.3  | pF   |
| R <sub>par</sub>   | parasitic resistance               | allowed resistance between adjacent pins                             | 20   | _    | _    | ΜΩ   |
| Reset              |                                    |  |      | •    | •    | •    |
| f <sub>o</sub>     | output frequency                   |  | _    | 32   | T-   | Hz   |
| $\Delta V_{o}$     | output voltage swing               | $R_L = 1 \text{ M}\Omega; C_L = 10 \text{ pF}$                       | 1.4  | _    | _    | V    |
| t <sub>r</sub>     | rise time                          | $R_L = 1 \text{ M}\Omega; C_L = 10 \text{ pF}$                       | _    | 1    | -    | μs   |
| t <sub>f</sub>     | fall time                          | $R_L = 1 \text{ M}\Omega; C_L = 10 \text{ pF}$                       | _    | 1    | -    | μs   |
| I <sub>i(av)</sub> | average input current              | pin RESET connected to $V_{DD}$ or $V_{SS}$                          | _    | 10   | 20   | nA   |

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#### **OTP PROGRAMMING CHARACTERISTICS**

| SYMBOL                 | PARAMETER <sup>(1)</sup>  | MIN. | TYP. | MAX. | UNIT |
|------------------------|---|------|------|------|------|
| $V_{DD}$               | supply voltage during programming procedure                       | 1.5  | _    | 3.0  | V    |
| V <sub>P(start)</sub>  | supply voltage for starting programming procedure                 | 6.6  | _    | 6.8  | V    |
| V <sub>P(stop)</sub>   | supply voltage for stopping programming procedure                 | 6.2  | _    | 6.4  | V    |
| V <sub>P(mod)</sub>    | supply voltage modulation for entering instructions               | 320  | 350  | 380  | mV   |
| V <sub>pre-store</sub> | supply voltage for pre-store pulse                                | 6.2  | _    | 6.4  | V    |
| V <sub>store</sub>     | supply voltage for writing to the OTP cells                       | 9.9  | 10.0 | 10.1 | V    |
| I <sub>store</sub>     | supply current for writing to the OTP cells                       | _    | _    | 10   | mA   |
| t <sub>p(start)</sub>  | pulse width of start pulse  | 8    | 10   | 12   | ms   |
| t <sub>p(stop)</sub>   | pulse width of stop pulse   | 0.05 | _    | 0.5  | ms   |
| t <sub>mod</sub>       | modulation pulse width  | 25   | 30   | 40   | μs   |
| t <sub>pre-store</sub> | pulse width of pre-store pulse                                    | 0.05 | _    | 0.5  | ms   |
| t <sub>store</sub>     | pulse width for writing to the OTP cells                          | 95   | 100  | 110  | ms   |
| t <sub>0</sub>         | waiting time after start pulse                                    | 20   | _    | 30   | ms   |
| t <sub>1</sub>         | pulse distance for incrementing the state counter                 | 0.6  | 0.7  | 0.8  | ms   |
| t <sub>2</sub>         | pulse distance for clocking the data register with data = logic 0 | 1.6  | 1.7  | 1.8  | ms   |
| t <sub>3</sub>         | pulse distance for clocking the data register with data = logic 1 | 2.6  | 2.7  | 2.8  | ms   |
| t <sub>4</sub>         | waiting time for writing to the OTP cells                         | 0.1  | 0.2  | 0.3  | ms   |
| SR                     | slew rate for modulation of the supply voltage                    | 0.5  | _    | 5    | V/μs |
| R <sub>read</sub>      | read out resistor for supply current modulation                   | 18   | 30   | 45   | kΩ   |

#### Note

1. Programme each word once only.

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#### **BONDING PAD LOCATIONS**

| SYMBOL                         | PAD | COORDI | NATES <sup>(1)</sup> |  |
|--------------------------------|-----|--------|----------------------|--|
| STIVIBUL                       | PAU | х      | у                    |  |
| V <sub>SS</sub> <sup>(2)</sup> | 1   | -480   | +330                 |  |
| i.c. <sup>(3)</sup>            | 2   | -480   | +160                 |  |
| OSCIN                          | 3   | -480   | -160                 |  |
| OSCOUT                         | 4   | -480   | -330                 |  |
| $V_{DD}$                       | 5   | +480   | -330                 |  |
| MOT1                           | 6   | +480   | -160                 |  |
| MOT2                           | 7   | +480   | +160                 |  |
| RESET                          | 8   | +480   | +330                 |  |

#### **Notes**

- 1. All coordinates are referenced, in  $\mu m$ , to the centre of the die (see Fig.11).
- The substrate (rear side of the chip) is connected to V<sub>SS</sub>. Therefore, the die pad must be either floating or connected to V<sub>SS</sub>.
- Pad i.c. is used for factory tests; in normal operation it should be left open-circuit, and it has an internal pull-down resistance to V<sub>SS</sub>.

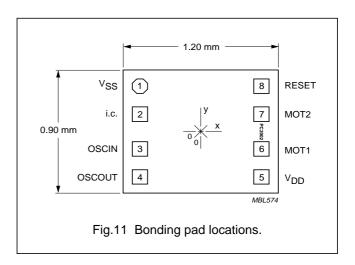


Table 5 Mechanical chip data; note 1

| PARAMETER    | VALUE                  |
|--------------|------------------------|
| Bonding pad: |                        |
| metal        | $96 \times 96 \ \mu m$ |
| opening      | $86 \times 86 \ \mu m$ |

#### Note

 The substrate of the chip is connected to V<sub>SS</sub>. The pad i.c. is used for factory test, in normal operation it should be left open-circuit. The pad i.c. has an internal pull-down resistor connected to V<sub>SS</sub>.

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#### TRAY INFORMATION

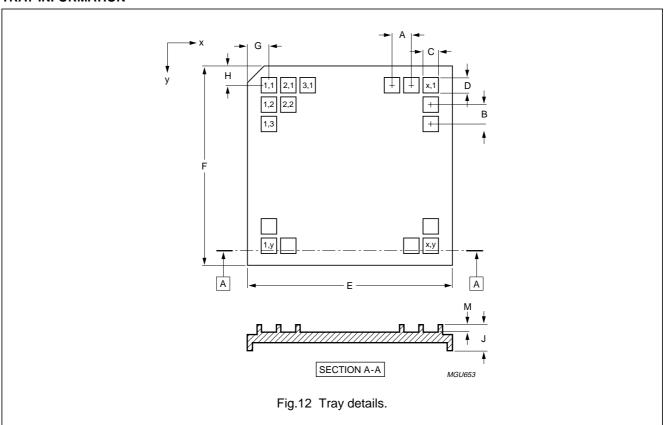
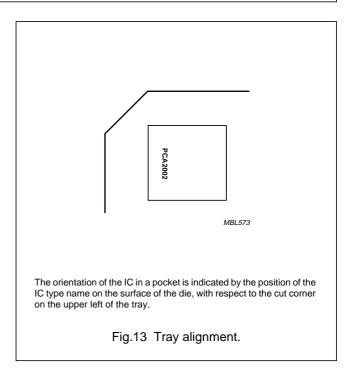


Table 6 Tray dimensions

|           | T   | T I      |
|-----------|---|----------|
| DIMENSION | DESCRIPTION   | VALUE    |
| Α         | pocket pitch; x direction                           | 2.15 mm  |
| В         | pocket pitch; y direction                           | 2.43 mm  |
| С         | pocket width; x direction                           | 1.01 mm  |
| D         | pocket width; y direction                           | 1.39 mm  |
| E         | tray width; x direction                             | 50.67 mm |
| F         | tray width; y direction                             | 50.67 mm |
| G         | distance from cut corner to pocket (1 and 1) centre | 4.86 mm  |
| Н         | distance from cut corner to pocket (1 and 1) centre | 4.66 mm  |
| J         | tray thickness                                      | 3.94 mm  |
| M         | pocket depth  | 0.61 mm  |
| х         | number of pockets in x direction                    | 20       |
| У         | number of pockets in y direction                    | 18       |



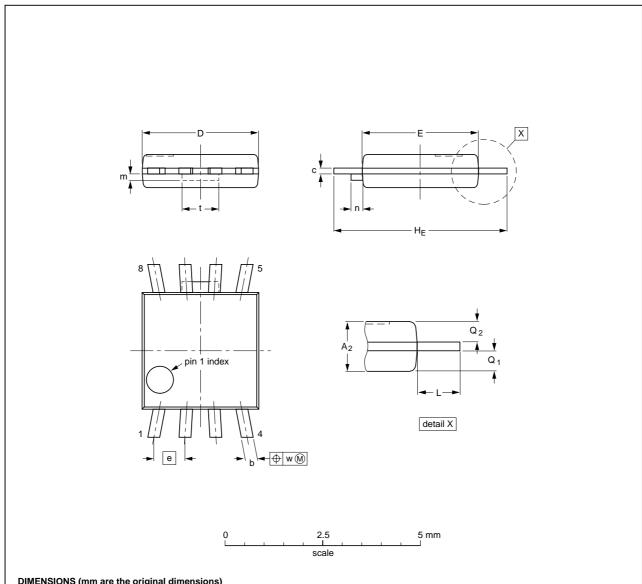
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#### **PACKAGE OUTLINE**

#### PMFP8: plastic micro flat package; 8 leads (straight)

SOT144-1



#### **DIMENSIONS** (mm are the original dimensions)

| UNIT | A <sub>2</sub> | b            | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е   | HE         | L    | m<br>max. | n<br>max. | Q <sub>1</sub> | Q <sub>2</sub> | t    | w   |
|------|----------------|--------------|--------------|------------------|------------------|-----|------------|------|-----------|-----------|----------------|----------------|------|-----|
| mm   | 0.9<br>0.7     | 0.40<br>0.25 | 0.19<br>0.12 | 3.1<br>2.9       | 3.1<br>2.9       | 0.8 | 4.6<br>4.4 | 0.75 | 0.26      | 0.3       | 0.4<br>0.3     | 0.4<br>0.3     | 0.95 | 0.1 |

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE  |     | REFER | EUROPEAN | ISSUE DATE |            |                                  |  |
|----------|-----|-------|----------|------------|------------|----------------------------------|--|
| VERSION  | IEC | JEDEC | JEITA    |            | PROJECTION | ISSUE DATE                       |  |
| SOT144-1 |     |       |          |            |            | <del>-95-01-24</del><br>03-03-12 |  |

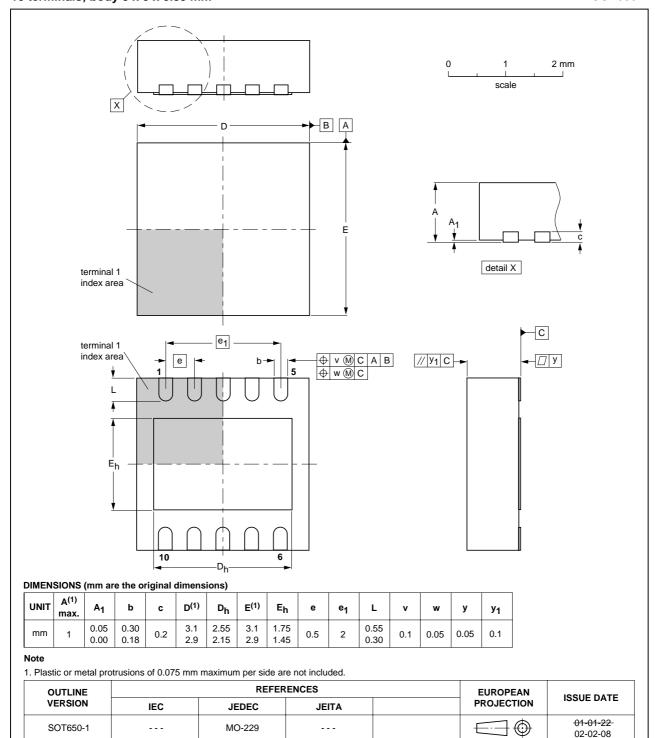
2004 Jan 20 14

### 32 kHz watch circuit with programmable output period and pulse width

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HVSON10: plastic thermal enhanced very thin small outline package; no leads; 10 terminals; body 3 x 3 x 0.85 mm

SOT650-1



### 32 kHz watch circuit with programmable output period and pulse width

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#### **SOLDERING**

#### Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

#### **Reflow soldering**

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 270 °C depending on solder paste material. The top-surface temperature of the packages should preferably be kept:

- below 225 °C (SnPb process) or below 245 °C (Pb-free process)
  - for all BGA, HTSSON-T and SSOP-T packages
  - for packages with a thickness ≥ 2.5 mm
  - for packages with a thickness < 2.5 mm and a volume ≥ 350 mm<sup>3</sup> so called thick/large packages.
- below 240 °C (SnPb process) or below 260 °C (Pb-free process) for packages with a thickness < 2.5 mm and a volume < 350 mm<sup>3</sup> so called small/thin packages.

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

#### Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
  - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320  $^{\circ}$ C.

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#### Suitability of surface mount IC packages for wave and reflow soldering methods

| PACKAGE <sup>(1)</sup>   | SOLDERING METHOD                  |                       |  |  |
|--|-----------------------------------|-----------------------|--|--|
| PACKAGE  | WAVE                              | REFLOW <sup>(2)</sup> |  |  |
| BGA, HTSSONT <sup>(3)</sup> , LBGA, LFBGA, SQFP, SSOPT <sup>(3)</sup> , TFBGA, USON, VFBGA | not suitable                      | suitable              |  |  |
| DHVQFN, HBCC, HBGA, HLQFP, HSO, HSOP, HSQFP, HSSON, HTQFP, HTSSOP, HVQFN, HVSON, SMS       | not suitable <sup>(4)</sup>       | suitable              |  |  |
| PLCC <sup>(5)</sup> , SO, SOJ  | suitable                          | suitable              |  |  |
| LQFP, QFP, TQFP  | not recommended <sup>(5)(6)</sup> | suitable              |  |  |
| SSOP, TSSOP, VSO, VSSOP  | not recommended <sup>(7)</sup>    | suitable              |  |  |
| CWQCCNL <sup>(8)</sup> , PMFP <sup>(9)</sup> , WQCCNL <sup>(8)</sup>                       | not suitable                      | not suitable          |  |  |

#### **Notes**

- 1. For more detailed information on the BGA packages refer to the "(LF)BGA Application Note" (AN01026); order a copy from your Philips Semiconductors sales office.
- 2. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
- 3. These transparent plastic packages are extremely sensitive to reflow soldering conditions and must on no account be processed through more than one soldering cycle or subjected to infrared reflow soldering with peak temperature exceeding 217  $^{\circ}$ C  $\pm$  10  $^{\circ}$ C measured in the atmosphere of the reflow oven. The package body peak temperature must be kept as low as possible.
- 4. These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- 5. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- 6. Wave soldering is suitable for LQFP, TQFP and QFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- 7. Wave soldering is suitable for SSOP, TSSOP, VSO and VSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.
- 8. Image sensor packages in principle should not be soldered. They are mounted in sockets or delivered pre-mounted on flex foil. However, the image sensor package can be mounted by the client on a flex foil by using a hot bar soldering process. The appropriate soldering profile can be provided on request.
- 9. Hot bar or manual soldering is suitable for PMFP packages.

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#### **DATA SHEET STATUS**

| LEVEL | DATA SHEET<br>STATUS <sup>(1)</sup> | PRODUCT<br>STATUS(2)(3) | DEFINITION   |
|-------|-------------------------------------|-------------------------|--|
| I     | Objective data                      | Development             | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.  |
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